ASSOCIATION CONNECTING ASSOCIATION CONNECTING LECTRONICS INDUSTRIES	IPC. Bannockl	ourn, Illinois, A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declarat he declaration of	ion of the su encompasse	ibstances v s all lower	within the manufacture level materials for w	rer listed in the rest of the	tem. Note: nanufacture	if the item is an as er has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information									
Supplier Information														
Company name* Com			Company unique ID			Unique ID Authority					Response Date*			
onsemi											2021-12-29			
Contact Name Title - Contact			et	Phone -			e - Contact*			Email -	Email - Contact*			
Product-Env-Stewards Product Env			viro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Represent			entative			Phone - Representative*			Email - Representative*					
Product-Env-Stewards Product En			Enviro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version Manufacturing Site			Weight*	UOM	Unit Type		
	NCV127	NCV12711ADNR2G Current Mode PW		M Controller		2021-12-29		N	MY1		25.19	mg	Each	
Ianufacturing Proccess Informa	ntion													
Terminal Plating / Grid Array M	laterial 7	Ferminal Base A	lloy J-STD-020 MSL Rat		L Rating	Peak Proc	eak Process Body Temperati		ure Max Time at Peak Tem		ture Num	ber of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30	secoi	nds 3			
omments														
vel 1 - maximum time at peak temperat	ure during so	ldering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.89	mg	Supplier	Silicon (Si)	7440-21-3		0.89	mg
Die Attach	0.1	mg		Epoxy resin	proprietary data		0.0025	mg
			Supplier	Silver (Ag)	7440-22-4		0.0845	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0025	mg
			Supplier	Inorganic filler	Proprietary Data		0.0025	mg
			Supplier	Dicyandiamine	461-58-5		0.0005	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0075	mg
Lead Frame	10.12	mg	Supplier	Zinc (Zn)	7440-66-6		0.0121	mg
			Supplier	Iron (Fe)	7439-89-6		0.2378	mg
			Supplier	Copper (Cu)	7440-50-8		9.867	mg
			Supplier	Phosphorus (P)	7723-14-0		0.003	mg
Mold Compound-Black	13.75	mg		Phenolic Resin	proprietary data		0.6875	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.275	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		0.6875	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0688	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		12.0312	mg
Plating	0.17	mg	Supplier	Tin (Sn)	7440-31-5		0.17	mg
Wire Bond - Au	0.16	mg	Supplier	Gold (Au)	7440-57-5		0.16	mg